

## Research Article

## Optimized graphene electrodes for contacting graphene nanoribbons

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## ABSTRACT

Atomically precise graphene nanoribbons (GNRs) are a promising emerging class of designer quantum materials with electronic properties that are tunable by chemical design. However, many challenges remain in the device integration of these materials, especially regarding contacting strategies. We report on the device integration of uniaxially aligned and non-aligned 9-atom wide armchair graphene nanoribbons (9-AGNRs) in a field-effect transistor geometry using electron beam lithography-defined graphene electrodes. This approach yields controlled electrode geometries and enables higher fabrication throughput compared to previous approaches using an electrical breakdown technique. Thermal annealing is found to be a crucial step for successful device operation resulting in electronic transport characteristics showing a strong gate dependence. Raman spectroscopy confirms the integrity of the graphene electrodes after patterning and of the GNRs after device integration. Our results demonstrate the importance of the GNR-graphene electrode interface and pave the way for GNR device integration with structurally well-defined electrodes.

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## 1. Introduction

New classes of electronic nanomaterials often require several years to decades of research to develop reliable electrical contacting approaches. For example, it took more than two decades to go from the first carbon nanotube (CNT) field-effect transistors to their successful integration into microprocessors [1–5]. Similar time-scales were also needed to develop the field of semiconducting

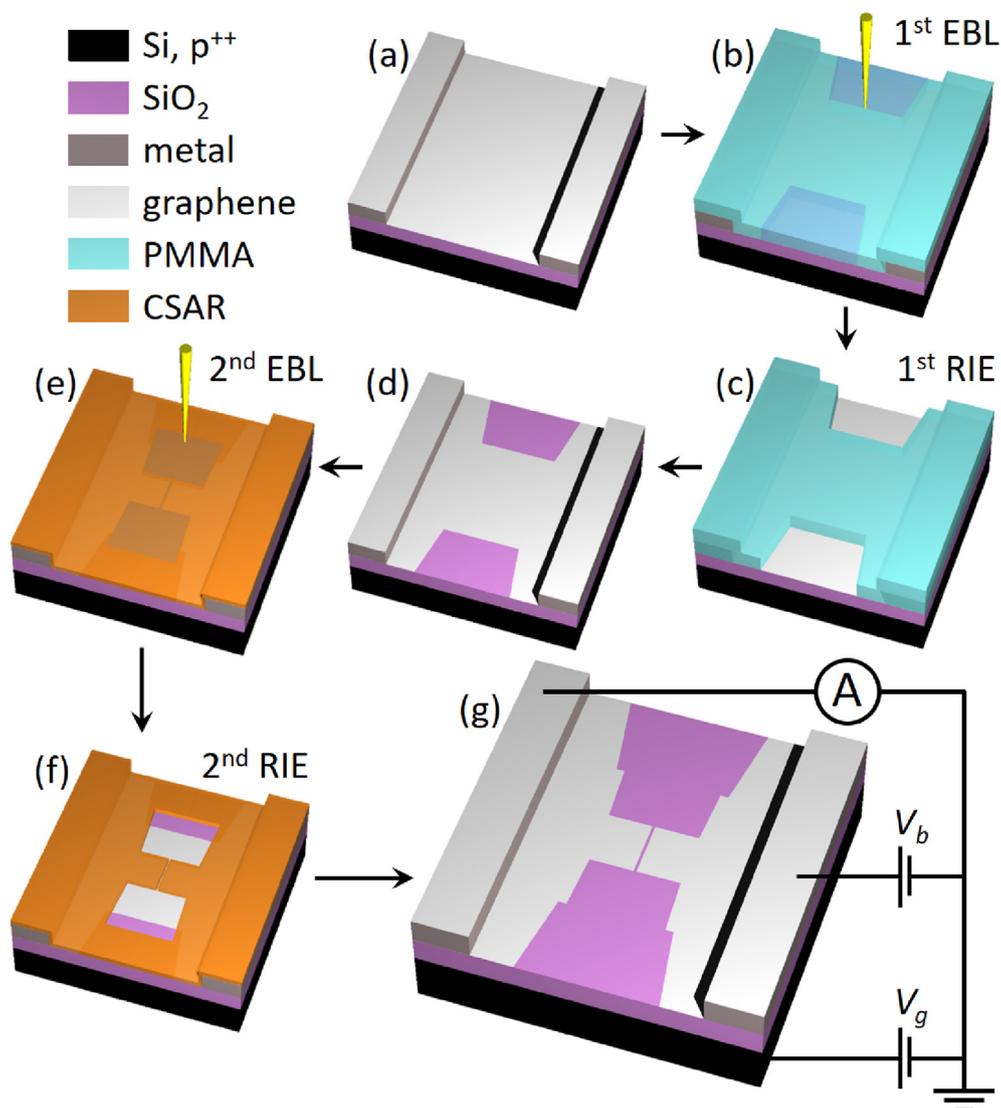
nanowires from the first reporting of Si-whiskers to their reliable use for quantum computing [6–8]. In the case of Si-nanowires, surface passivation of the contact area and thermal annealing were found to increase device performance significantly [9]. More recently, bottom-up synthesized atomically precise graphene nanoribbons (GNRs) have attracted a lot of attention as their electronic and magnetic properties can be tailored by bottom-up synthesis. However, contacting GNRs using top-down fabrication processes turned out to be highly demanding, in particular, because of their nanoscale dimensions of around 1 nm in width and lengths typically reaching 5–50 nm [10–16].

Standard electron beam lithography and metallization processes have been used by several groups for contacting GNRs [12,17,18]. However, these methods involve processing and metallization on top of transferred GNRs and can lead to the introduction of

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**Fig. 1.** Fabrication procedure and electrical measurement configuration. (a)–(g) Three-dimensional illustration describing the fabrication steps of the EBL defined graphene electrodes. The resist regions exposed during electron beam lithography are marked with darker colors. Arrows indicate fabrication order. The electrical measurement configuration is schematically shown in the last, slightly larger, illustration. See main text for details. (A colour version of this figure can be viewed online.)

contaminants at the contact-GNR interface and/or GNR damage. This approach is particularly problematic for GNRs with reactive and/or functionalized edges [19–22]. Alternatively, GNRs have also been transferred on top of predefined metal electrodes [23]. This approach may be suitable for GNR films in which hopping of charge carriers over larger distances is the dominating effect on transport properties but may lead to ill-defined 3-dimensional junction geometries when contacting a single GNR. Furthermore, metal electrodes in short-channel devices lead to the formation of image charges and screen the applied electrostatic gate field used to tune the electronic transport, requiring advanced gating approaches such as ionic liquid gating for reaching a sufficient gating efficiency [12,24–26]. Finally, we expect that the disorder of metallic electrodes at the atomic scale leads to uncontrolled local electrostatic potential surrounding the nanoscale object, a problem that 2D covalent crystals have the potential to overcome.

The above-mentioned issues can be addressed by the use of graphene electrodes. Graphene, with its monoatomic thickness, allows for the GNRs to be transferred on top of the electrodes, without introducing significant bending of the GNRs that bridge the

source and drain electrodes. The  $\pi$ - $\pi$  orbital overlap is widely used for contacting two-dimensional materials [27,28] and the charge carrier density in the graphene leads can be tuned by electrostatic gating. Graphene electrodes fabricated using the well-established electrical breakdown procedure result in gaps separating the electrodes by a few nanometers and are a suitable way to contact graphene nanoribbons of various types [11,13,29–32]. However, inherent geometric variation in such electrodes requires particular care during data analysis. This is necessary to disentangle the signal of the material under study from the direct tunneling current contributions, potential localized lead states, and to exclude reconnected graphene electrodes or connected graphene islands [33–36]. Moreover, the long fabrication time for each gap impacts the scalability of this approach.

Here, we report on graphene electrodes fabricated by electron beam lithography (EBL) using the combination of an optimized etch mask and etching recipe, which results in electrode separations down to <15 nm. This clean and well-defined electrode geometry helps to overcome the challenges emphasized above and represents an appealing platform to contact GNRs with a length above

15 nm. Such geometries allow for probing quantum materials in which long-range effects are at play, such as GNRs exhibiting topological phases or spin chains [20,21,37]. Moreover, the availability of large-scale graphene produced by chemical vapor deposition (CVD) allows us to fabricate up to 1680 devices per  $2 \times 2$  cm chip.

We demonstrate the suitability of our nanofabrication approach by integrating atomically precise 9-atom wide armchair graphene nanoribbons (9-AGNRs) in a field-effect transistor (FET) device [38]. 9-AGNRs are the ideal testing material due to their long-term stability and their well-studied transport properties [39,40]. In addition, we show that thermal annealing is an efficient way to enhance the electrical device properties leading to an increase in the on-state current of up to an order of magnitude at room temperature. Moreover, our gate-dependent electrical transport measurements show on-off ratios reaching values as high as  $10^4$ . The results obtained in this work open perspectives for the integration of different types of GNRs in more complex device geometries.

## 2. Experimental

### 2.1. Graphene growth and transfer

Polycrystalline graphene is synthesized via chemical vapor deposition (CVD) in a tube furnace (Three zone HZS, Carbolite). A 25  $\mu\text{m}$  thick copper (Cu) foil (Foil 2017, No. 46365, Alfa Aesar) is prepared at room temperature by first cleaning it in acetone (15 min), rinsing in isopropanol (IPA), immersion in deionized (DI) water (5 min), acetic acid (30 min), DI-water (20 min +5 min in an ultrasonic bath), ethanol (1 min), and blown dry with  $\text{N}_2$  before a reduction annealing in an  $\text{H}_2$ -rich atmosphere (20 sccm  $\text{H}_2$  in 200 sccm Ar) at 1000  $^\circ\text{C}$  and  $<1$  mbar for 60 min. Before the growth, the pressure inside the tube is increased to 110 mbar by partially closing the downstream valve. Graphene growth is initiated by the addition of 0.04 sccm  $\text{CH}_4$  to the chamber for 22 min. The growth is terminated by stopping the  $\text{CH}_4$  flow, reducing the pressure by opening the downstream valve, opening the lid of the tube furnace, and circulating air with a fan to allow for an abrupt drop in temperature. The cool down procedure (to  $<100$   $^\circ\text{C}$ ) takes 45 min. The as-grown single-layer graphene is transferred onto a specially-developed substrate for device integration of GNRs (target substrate) using a wet transfer method [41]. This target substrate contains Ti/Pt contact pads (5 nm/100 nm) evaporated onto Si/SiO<sub>2</sub> (500  $\mu\text{m}$ /285 nm) gate/gate oxide substrate (thickness in brackets). Poly(methyl methacrylate) (PMMA) 50K (AR-P 632.12, Allresist GmbH) is spun onto the graphene-coated Cu foil and the backside graphene is etched using reactive ion etching (RIE). Cu is etched away using a copper etchant (PC COPPER ETCHANT-100, Transene) for 60 min leaving the graphene/PMMA film floating on top. The etchant is then replaced by DI-water in a stepwise dilution process. The DI-water is then replaced by a 10% HCl solution for 5 min. After a final rinsing in DI-water, the graphene/PMMA film is fished out with the target substrate. After settling under ambient conditions for 30 min, the target substrate/graphene/PMMA stack is placed in an oven and heated to 80  $^\circ\text{C}$  for 1 h followed by a second heating step at 80  $^\circ\text{C}$  for at least 12 h under vacuum conditions ( $<1$  mbar) to ensure good adhesion of the graphene to the target substrate. PMMA is removed in acetone for 10 min at room temperature, 60 min at 56  $^\circ\text{C}$ , followed by a 30 min cool down period. Finally, we perform an IPA rinsing step followed by  $\text{N}_2$  dry blowing. This process yields clean, single-layer graphene with low defect density on the target substrate as illustrated in Fig. 1(a), see Fig. S1 for graphene quality assessment [42].

### 2.2. Graphene patterning

To define graphene electrodes, graphene on Si/SiO<sub>2</sub> with pre-defined metal electrodes and optimized areas for Raman spectroscopy is patterned by EBL as detailed below. Two exposure steps (100 kV write mode, EBPG5200, Raith GmbH) are done, each followed by an RIE step. For the first exposure step, the sample with graphene is spin-coated with 160 nm thick PMMA 50K (AR-P 632.06, Allresist GmbH) and 90 nm thick PMMA 950K (AR-P 672.02, Allresist GmbH), each baked at 180  $^\circ\text{C}$  on a hotplate for 5 min, as illustrated in Fig. 1(b). Following a first electron beam exposure, the resist is developed in Methyl-isobutyl-ketone (MIBK):IPA (1:3) at room temperature for 60 s, see Fig. 1(c). RIE (15 sccm Ar, 30 sccm O<sub>2</sub>, 25 W, 18 mTorr) for 30 s is used to remove the accessible graphene. PMMA is removed using acetone, IPA, and  $\text{N}_2$  dry blow, see Fig. 1(d). After this pre-patterning of the graphene, a second EBL and RIE step (same etching plasma parameters as above, reduced time of 6 s) are carried out to separate the graphene electrodes, as illustrated in Fig. 1(e)–(g).

Two different approaches for the fabrication of etch masks were investigated:

- i) **CSAR mask:** In the first approach, a 60 nm thick CSAR resist (AR-P 6200.04, Allresist GmbH) is spin-coated. Following the second electron beam exposure, the resist is developed using a suitable developer (AR 600-546, Allresist GmbH) at room temperature for 1 min followed by an IPA rinse. After RIE, the etching mask is removed by immersing in 1-Methyl-2-pyrrolidinone (NMP) (Sigma Aldrich) at room temperature for 10 min followed by 60 min at 80  $^\circ\text{C}$ , cooled down for 30 min, rinsed with IPA, and blown dry with  $\text{N}_2$ .
- ii) **PMMA mask and cold development:** In the second approach, a 60 nm thick layer of PMMA 950K (AR-P 672.02, Allresist GmbH) diluted in anisole (1:1) is spin-coated. The development of the resist after electron beam exposure is done in MIBK:IPA (1:3) at 2  $^\circ\text{C}$  for 45 s followed by an IPA rinse at 2  $^\circ\text{C}$  for 10 s. After RIE the etch mask is removed in the same way as after the first RIE step.

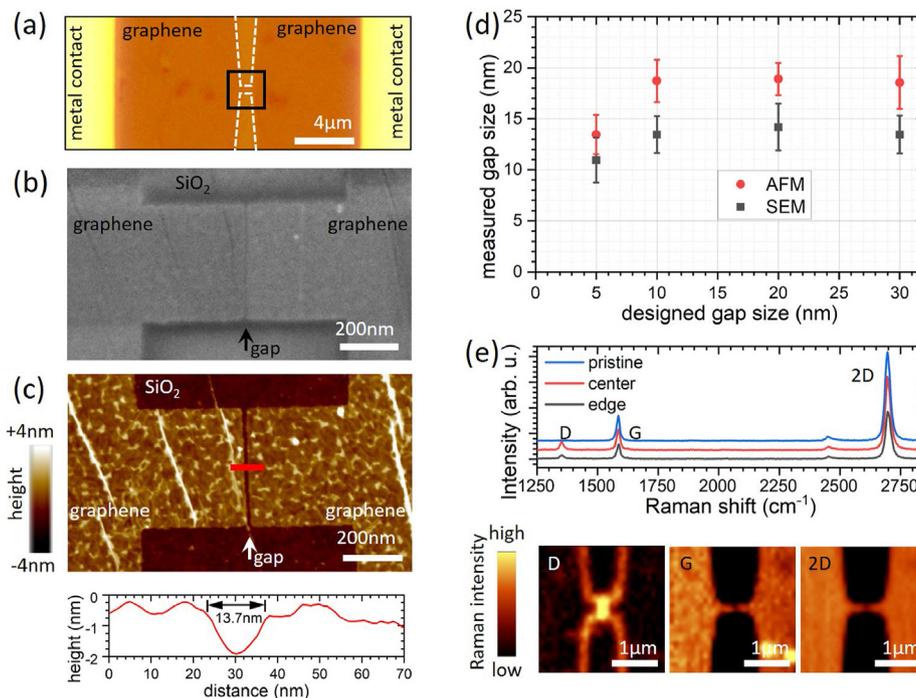
Both approaches yield clean and well-separated graphene electrodes with reproducible gap sizes (see Results and Supporting Information).

### 2.3. Graphene electrode separation

The separation of graphene electrodes (gap size) is assessed using scanning electron microscopy (SEM) (Helios 450, FEI), and atomic force microscopy (AFM) (Icon, Bruker) is employed to independently determine the electrode separation. The AFM is equipped with a sharp cantilever (tip radius = 2 nm) (SSS-NCHR-20, Nanosensors) operated in soft-tapping mode. The electrode separation by AFM is determined via a Python script, based on the nanoscope library [43]. Each line scan is smoothed individually using a Savitzky-Golay filter and the edges of the gap are determined by selecting the local maxima and minima in the first derivative on either side of the gap minimum. It was not possible to apply the same procedure to the SEM data due to the low contrast between the graphene and the SiO<sub>2</sub> of the target substrate and the small separation of the graphene electrodes. Therefore, the average and standard deviation are obtained from 20 manual measurements that are equally spaced along the gap.

### 2.4. Graphene quality after patterning

The patterned graphene electrodes are analyzed in air by 2D Raman mapping (Alpha300R, WITec) using a 488 nm incident laser



**Fig. 2.** Electrode separation of devices fabricated using CSAR mask. (a) Optical image of a representative device. The central region of the same device is shown in (b) an SEM image and in (c) a height profile (AFM scan) including a line cut through the central region (red) showing the electrode separation. (d) Electrode separations measured by SEM and AFM for four devices with different gap sizes. (e) Raman intensity maps for D-, G- and 2D-bands in the area indicated with a black square in (a) and spectra extracted at representative positions. (A colour version of this figure can be viewed online.)

beam at 1.5 mW and a 100× objective (NA = 0.9) with a pixel spacing of 100 nm [41].

### 2.5. On-surface synthesis of 9-AGNRs and transfer to a device substrate

9-AGNRs were synthesized from 3',6'-diiodo-1,1':2',1''-terphenyl (DITP), see Fig. 4(a) for the chemical structure of a 9-AGNR [10].

9-AGNRs are transferred from their growth substrate to the silicon-based target substrates with predefined graphene electrodes by two different transfer approaches. 9-AGNRs grown on Au(788) crystals are transferred by an electrochemical delamination method using PMMA as described previously [41,44,45]. 9-AGNRs grown on Au(111)/mica are transferred using a polymer-free method as described elsewhere [17,39,46].

Using Au(788) as growth substrate results in uniaxially aligned 9-AGNRs (GNRs grown along the narrow (111) terraces) while using Au(111)/mica leads to non-aligned 9-AGNRs [47,48]. In both cases, Au(788) single crystal (MaTeK, Germany) or Au(111)/mica growth substrates (Phasis, Switzerland) are cleaned in ultrahigh vacuum by two sputtering/annealing cycles: 1 kV Ar<sup>+</sup> for 10 min followed by annealing at 420 °C for Au(788) and 470 °C for Au(111)/mica for 10 min. Next, the precursor monomer DITP is sublimed onto the Au surface from a quartz crucible heated to 70 °C, with the growth substrate held at room temperature. After deposition of 1 monolayer DITP, the growth substrate is heated (0.5 K/s) to 200 °C with a 10 min holding time to activate the polymerization reaction, followed by annealing at 400 °C (0.5 K/s with a 10 min holding time) to form the GNRs via cyclodehydrogenation. The average GNR length is around 40–45 nm [10].

### 2.6. Electronic measurements

All electronic measurements are performed under vacuum

conditions ( $<10^{-6}$  mbar) in two different probe stations. The FETs consisting of aligned GNRs using the polymer-assisted transfer are characterized in a custom-built probe station equipped with nanoprobe (miBot, Imina Technologies SA). A data acquisition board (USB-6289, National Instruments) is employed to apply the bias and gate voltages and read the voltage output of a custom-made I–V converter (Model SP983, Basel Precision Instruments GmbH). The FETs consisting of GNRs using the polymer-free transfer method are characterized in a commercially available probe station (Model CRX-6.5K, Lake Shore Cryogenics). A data acquisition board (ADwin-Gold II, Jäger Computergesteuerte Messtechnik GmbH) is employed to apply the bias and gate voltages and read the voltage output of the I–V converter (DDPCA-300, FEMTO Messtechnik GmbH).

The thermal annealing was performed at 150 °C for 30 min in a dedicated vacuum chamber ( $<10^{-6}$  mbar). The annealed samples are transferred through air to the measurement chamber.

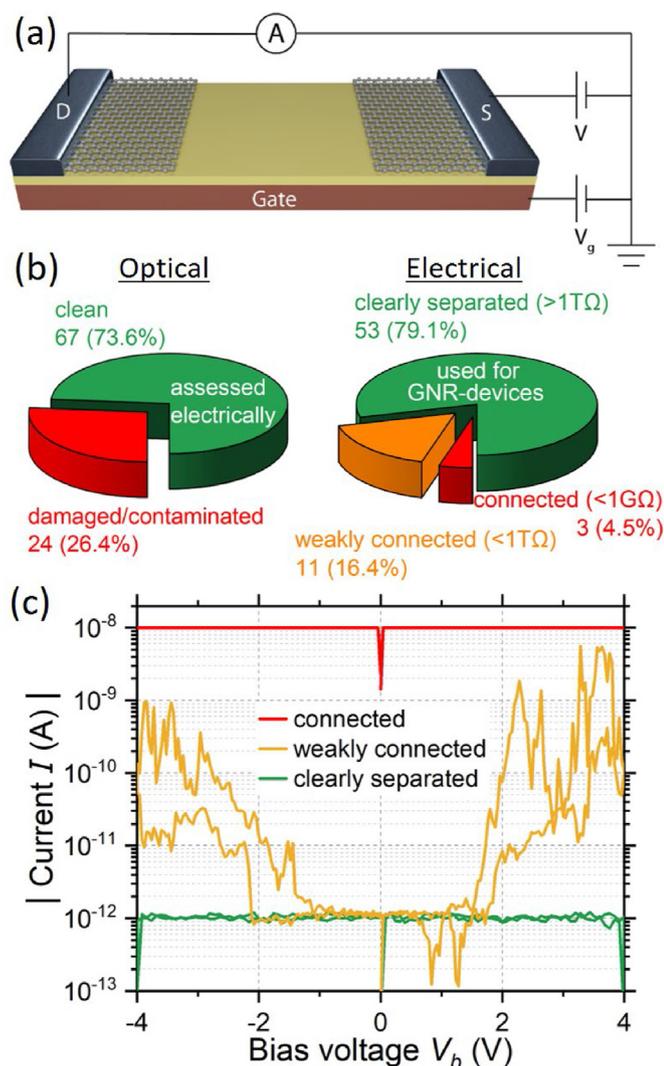
## 3. Results and discussion

### 3.1. Graphene electrodes

The fabrication process yielding graphene electrodes for contacting graphene nanoribbons is illustrated in Fig. 1 and described in detail in the experimental section.

We stress that for etching nanogaps into graphene the interplay of the used etch masks, their removal, as well as the chosen etching parameters, plays an even more crucial role in obtaining the wanted feature resolution than for evaporated features.

First, it is crucial to split the resist exposure by electron beam into two steps to ensure the proximity-effect, while writing the coarse features, does not affect the sensitive exposure of the nanogap. For the second exposure, we use a beam step size of 5 nm and beam current of 3 nA (resulting in a beam diameter of 5 nm). Second, for the first RIE step to pattern the coarse features, a double



**Fig. 3.** (a) Illustration of the electrical measurement scheme for characterizing the separation of the graphene electrodes. (b) Statistics on electrode separation by optical and electrical assessment. (c)  $I$ – $V$  characteristics of three representative devices before 9-AGNR transfer. (A colour version of this figure can be viewed online.)

layer etch mask is employed that helps reduce contaminations on graphene by using a low molecular weight resist in direct contact with the graphene and a high molecular weight resist on top for high contrast and feature definition. We note that the undercut in the double layer resist does not pose a problem, as the feature sizes in this first RIE step are not critical. For the second RIE step, an undercut is unwanted since it would result in a larger electrode separation. The smallest graphene electrode separation ( $<15$  nm) is achieved using CSAR resist, due to its excellent performance in terms of resolution, sensitivity, and etch resistance [49].

Third, we emphasize that the duration of the second RIE step has to be short enough to avoid a sideways etching of the resist mask but long enough that the monolayer graphene is fully etched. This trade-off leads to a delicate balance between device yield and electrode separation. Last, the removal of the etch mask has to be done using processes that are sufficiently mild to preserve the graphene quality but sufficiently harsh to leave little residues on the electrodes. We therefore, employed only acetone and NMP since their effects on graphene quality are well studied [50–53].

Since the used GNR growth substrates do not exceed  $5 \times 5$  mm in size, after fabrication the chip is broken into smaller pieces with

100–200 devices each before the GNRs to target substrate transfer.

### 3.2. Characterization of patterned graphene electrodes

Before the electrode separation is assessed, an optical inspection of the graphene electrodes is carried out. Graphene electrodes containing graphene folds in the central region or those damaged during the fabrication process are excluded from further investigation. A typical optical image of the graphene electrodes can be seen in Fig. 2(a).

The electrode separation is assessed by SEM and AFM and representative scans are shown in Fig. 2(b) and 2(c), respectively, with in Fig. 2(d) extracted gap sizes. We find that the graphene electrodes fabricated with the CSAR etch mask (see experimental section) are separated by  $<15$  nm for the smallest designed geometry. The fabrication method using the PMMA etch mask yields a slightly larger electrode separation of around 27 nm in the smallest case (See Fig. S3). Hence, these electrodes are only used for the uniaxially aligned 9-AGNRs to have high device yields. Fig. 2(d) also shows that the measured electrode separation for the CSAR etch mask does not scale linearly with the width of the gap in the design. We attribute this behavior to the proximity-effect correction procedure that is applied for the exposure dose calculation.

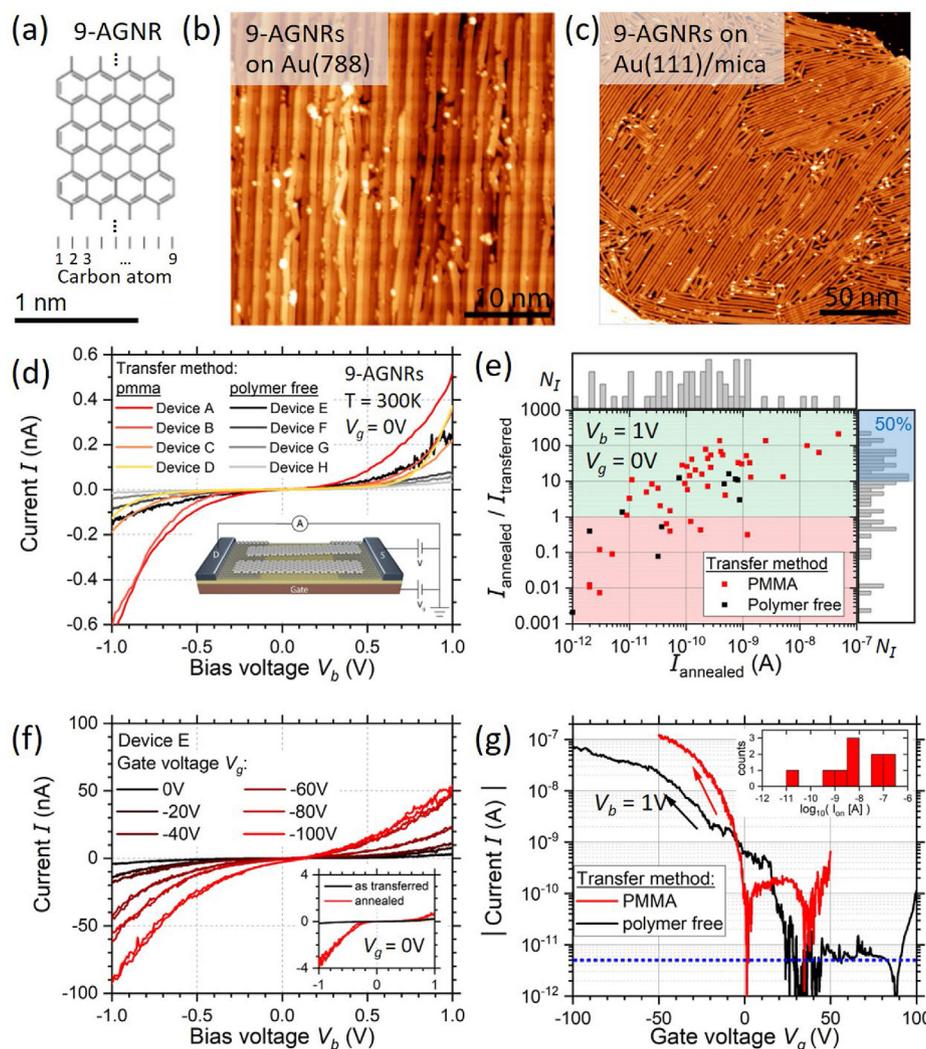
For a successful device integration of GNRs, we consider it important to have graphene electrodes with little to no defects after patterning. Raman spectroscopy maps confirm the high quality of the graphene electrodes after processing (see Fig. 2(e)). The D-band intensity map shows negligible intensity in the pristine area and an intensity increase at the edges and in the nanogap region. Raman spectroscopy further revealed a clear drop in the intensity of the G- and 2D-bands where the graphene electrodes are separated, indicating a lower amount of carbon and breaking of the crystal structure. The 488 nm excitation source was chosen to reach a minimal laser spot size for best spatial resolution. The high graphene quality was also confirmed by measuring the current versus applied gate voltage of a reference device that underwent the same fabrication procedure except for the 2nd RIE step, revealing field-effect mobilities of  $2'500$   $\text{cm}^2/\text{Vs}$  for electrons and  $1'800$   $\text{cm}^2/\text{Vs}$  for holes (see Fig. S3).

We optically assessed 91 devices for the two transfer methods based on which we excluded 24 devices. After the initial optical assessment and prior to the 9-AGNR transfer, each device is characterized electrically. A schematic illustration of the electronic wiring for the latter is depicted in Fig. 3(a). As shown in Fig. 3(b) a high yield of clearly separated graphene electrodes ( $>1$  T $\Omega$ ) of 79.1% is found. The remaining 20.9% of graphene electrodes are either weakly ( $<1$  T $\Omega$ ) or fully connected ( $<1$  G $\Omega$ ). Representative  $I$ – $V$  characteristics for the three cases are shown in Fig. 3(c). Of the 67 devices with clearly separated graphene electrodes, 56 devices showed a signal after transfer of 9-AGNRs, leading to a total device yield of 61.5%.

Reasons for the not well-formed nanogaps may include the presence of (partially etched) multilayer graphene at the constriction and contamination during/after processing. These devices are not investigated further.

### 3.3. Electrical characterization and effect of annealing

After the initial characterization of the devices, 9-AGNRs were transferred on top of the graphene electrodes. Fig. 4(b) and (c) show high-resolution scanning tunneling microscope (STM) images of 9-AGNRs on the growth substrates presenting their alignment. We note that the growth and transfer methods were adapted to the gapsizes. For the devices fabricated using the PMMA mask (gapsizes  $\sim 27$  nm), uniaxially aligned GNRs were transferred with



**Fig. 4.** (a) Chemical structure of a 9-atom wide armchair graphene nanoribbon (9-AGNR). STM topography images of 9-AGNRs grown on (b) Au(788) (RT,  $V_S = -1.3$  V,  $I_t = 30$  pA) and (c) Au(111) ( $T = 4.2$  K,  $V_S = -1.5$  V and  $I_t = 5$  pA). (d) I–V characteristics of four representative 9-AGNR devices for each of the two transfer methods before thermal annealing. (e) The main panel shows the ratio of current values measured before and after thermal annealing of the devices at  $150$  °C. Current increase and decrease are highlighted in green and red, respectively. Histograms of  $I_{\text{annealed}}$  and  $I_{\text{annealed}}/I_{\text{transferred}}$  are shown in the outer panels on the top and the right, respectively. Highlighted in blue are 50% of the devices. (f) I–V characteristics of device E recorded at different applied gate voltages after annealing. Inset shows the effect of annealing on the I–V characteristics. (g) Current – gate voltage dependence at fixed bias voltage for two devices. Arrows indicate the direction of the gate sweep. The blue dashed line indicates the noise floor of the I–V converter. The inset shows a histogram of the on-currents. (A colour version of this figure can be viewed online.)

perpendicular orientation to the gap to maximize the chance of bridging both electrodes. For the devices fabricated using the CSAR mask (gapsize  $< 15$  nm), based on geometrical considerations, we anticipate a higher probability of bridging that allows for investigating non-aligned 9-AGNRs transferred using a polymer-free method. In both cases, the integrity of the 9-AGNRs after the transfer process was confirmed by Raman spectroscopy (see Fig. S5). In particular, the presence of the longitudinal compressive mode (LCM) is strong evidence for the high quality of the 9-AGNRs after the transfer process due to its high sensitivity to structural damage [45]. Polarization-dependent Raman measurements further reveal for the aligned GNRs a minor misalignment to the source-drain axis that is preserved upon thermal annealing (see Fig. S5). Fig. 4(d) shows typical I–V characteristics recorded at room temperature under vacuum conditions ( $< 10^{-6}$  mbar) on different devices fabricated using the two transfer methods. We observe highly nonlinear I–V curves with currents up to  $0.5$  nA at  $1$  V bias voltage. The inset presents a schematic of the device and the electrical characterization scheme. The non-linearity in the I–V curve is typical for large bandgap GNRs, where charge transport

occurs when the conduction or valence band enters the bias window. This observation is in accordance with reported I–V shapes for supported and suspended narrow GNRs [12,31,54].

To improve the maximum currents through the devices, we investigated the effect of thermal annealing. As the transfer of the 9-AGNRs onto the target substrate exposes the graphene to humidity and water, the samples were heated to  $150$  °C for  $30$  min at  $10^{-6}$  mbar in a separate annealing chamber to remove water residues at the graphene/GNR interface. The heating also provides energy for local geometric rearrangements. To evaluate the benefit of this thermal treatment, the maximum currents observed at a gate voltage of  $0$  V and a bias voltage of  $1$  V are compared before (as transferred,  $I_{\text{transferred}}$ ) and after thermal annealing ( $I_{\text{annealed}}$ ). Fig. 4(e) shows a scatter plot of the ratio  $I_{\text{annealed}}/I_{\text{transferred}}$  for all devices. Over all samples, an increase by one order of magnitude or higher in 50% of the devices is observed, with individual junctions showing an increase as high as a factor of  $100$ .

During annealing, several processes can take place and affect the conductance of the junctions. By reducing the number of water adsorbates at the GNR-graphene interface, the two nanomaterials

can go into a more intimate contact, which can lead to an increased electronic coupling similar to what has been observed for decoupled graphene monolayers [55,56]. Water removal may also result in reduced doping of the GNRs, leading to a probing of the more intrinsic GNR transport properties, similar to what has been reported for graphene FETs on SiO<sub>2</sub> [57,58]. Studies of molecules with planar anchor groups on graphene electrodes revealed that the binding energy to sliding and bending is around 0.01 eV, significantly lower than the energy  $k_B T$  (~0.04 eV) provided during the thermal annealing process [59–61]. Hence, this energy likely is sufficient to cause local displacement and geometrical rearrangements of the GNRs that can lead to both improved contact but also loss of GNRs within the junction and a decrease of overall conductance in multi-GNR junctions as can be seen by a conductance decrease in about 20% of the devices after annealing. We note that at the annealing temperature used, no lateral fusion of GNRs is expected [31,62].

In Fig. 4(f), we show measured current-voltage characteristics at various applied gate voltages. The plot indicates slightly asymmetric characteristics with a strong gate dependence. The presence of only little hysteresis effects between the up and down sweep of the applied bias voltage indicates high device stability. The observed hysteresis is attributed to the influence of trap states in the oxide [63]. Fig. 4(g) shows a measurement of the current as a function of gate voltage for two devices, recorded at a fixed applied bias voltage of 1 V (extended data see Fig. S6). The traces show a drastic increase of the conductance for negative gate voltages, pointing towards hole transport through the valence band (or highest occupied molecular orbital (HOMO)) [12]. The gentle increase in conductance at positive gate voltages suggests the presence of another transport channel entering the bias window, presumably the conduction band (or lowest unoccupied molecular orbital (LUMO)). In the gate sweeps, we obtain maximal on-off ratios of up to 10<sup>4</sup>, with an on-current of 70 nA at a gate voltage of –100 V and an off-current of 5 pA at a gate voltage of +40 V for the black curve in Fig. 4(d). The maximum observed values for the on-off ratios is about a factor of 100 higher than reported by Martini et al. and El Abbassi et al. contacting 9-AGNRs using graphene electrodes fabricated by electrical breakdown, and about a factor 50 higher than reported by Jangid et al. for top-down fabricated GNRs [11,31,64].

Finally, we used the newly developed graphene electrode platform to probe the transport properties of pyrene-GNRs. This type of GNR has partially zig-zag edges, a low bandgap and is near a topological phase boundary [13]. As these GNRs contain several edge segments with a zigzag termination that may be more reactive than its armchair counterpart, the thermal annealing step was not performed. The transport measurements at room temperature reveal almost linear I–V characteristics and no gate-dependence (see Fig. S7). Such behaviour is expected for low bandgap GNRs and is in accordance with results obtained on devices where the graphene electrodes are separated using the electric breakdown procedure [11,13].

#### 4. Conclusions

We successfully integrated 9-AGNRs in a FET geometry using graphene electrodes fabricated via optimized e-beam lithography and reactive ion etching resulting in electrode separations as small as <15 nm. Room-temperature electrical transport measurements revealed nonlinear current-voltage characteristics and a strong gate dependence. Furthermore, we find that thermal annealing improves the on-currents after annealing by at least one order of magnitude in 50% of the investigated devices. In addition, we performed gate sweeps revealing on-off ratios as high as 10<sup>4</sup> with the

highest on-currents of 70 nA at a bias voltage of 1 V.

The developed technology to fabricate graphene electrodes separated by <15 nm is a major step forward towards all-carbon electronics and offers encouraging prospects for room-temperature ambipolar 9-AGNR-FET behavior. The presented platform allowed to measure transport through GNRs with partially zigzag edges with an electrode separation of >10 nm and could also be applied for short channel FETs using two-dimensional materials as channel material, as reported for MoS<sub>2</sub> or phase-change memory devices [65,66]. Finally, the location of the gap is well defined, allowing for advanced gating geometries in which for instance a local gate is defined below the gap and additional gates are fabricated below the graphene. Such an architecture would allow for separately tuning the charge carrier density in the graphene electrodes and the electrostatic potential applied to the contacted GNRs. Importantly, this platform will allow for the integration of GNRs of different widths as well as different edge structures for exploring more exotic transport properties [13,67].

Acknowledgments.

#### Data availability

The data that support the findings of this study are available from the corresponding author upon reasonable request.

#### CRediT authorship contribution statement

**Oliver Braun:** Conceptualization, Methodology, Investigation, Writing – original draft, Writing – review & editing, Visualization, Project administration. **Jan Overbeck:** Conceptualization, Methodology, Investigation, Writing – original draft, Visualization. **Maria El Abbassi:** Investigation. **Silvan Käser:** Investigation. **Roman Furrer:** Resources. **Antonis Olziersky:** Investigation. **Alexander Flasby:** Software. **Gabriela Borin Barin:** Writing – original draft, Resources. **Qiang Sun:** Resources. **Rimah Darawish:** Resources. **Klaus Müllen:** Resources. **Pascal Ruffieux:** Supervision. **Roman Fasel:** Funding acquisition, Supervision. **Ivan Shorubalko:** Conceptualization, Methodology. **Mickael L. Perrin:** Writing – original draft, Writing – review & editing, Visualization, Supervision. **Michel Calame:** Conceptualization, Writing – original draft, Writing – review & editing, Visualization, Funding acquisition, Supervision.

#### Declaration of competing interest

The authors declare that they have no known competing financial interests or personal relationships that could have appeared to influence the work reported in this paper.

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## Appendix A. Supplementary data

Supplementary data to this article can be found online at <https://doi.org/10.1016/j.carbon.2021.08.001>.

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